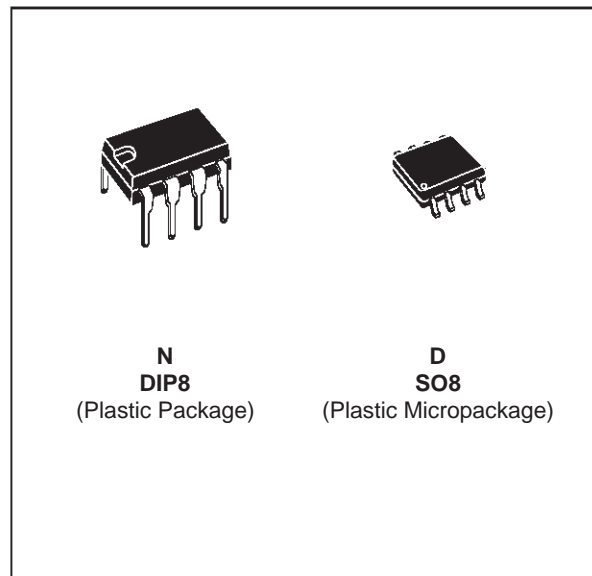




# TS912

## RAIL TO RAIL CMOS DUAL OPERATIONAL AMPLIFIER

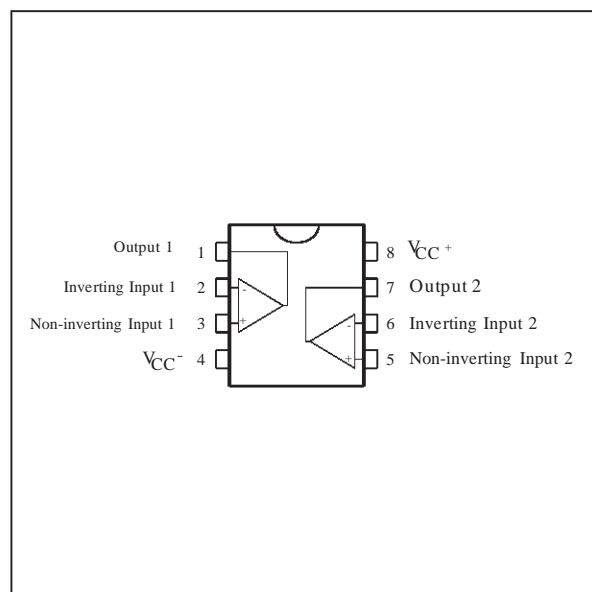
- RAIL TO RAIL INPUT AND OUTPUT VOLTAGE RANGES
- SINGLE SUPPLY OPERATION FROM **2.7V TO 16V**
- EXTREMELY LOW INPUT BIAS CURRENT : **1pA** typ
- LOW INPUT OFFSET VOLTAGE : **2mV max.**
- SPECIFIED FOR **600Ω** AND **100Ω** LOADS
- LOW SUPPLY CURRENT : 200μA/Ampli ( $V_{CC} = 3V$ )
  
- ESD TOLERANCE : 3KV
- LATCH-UP IMMUNITY
  
- **MACROMODEL** INCLUDED IN THIS SPECIFICATION



### ORDER CODES

Part Number	Temperature Range	Package	
		N	D
TS912I/AI/BI	-40, +125°C	•	•

### PIN CONNECTIONS (top view)



### DESCRIPTION

The TS912 is a RAIL TO RAIL CMOS dual operational amplifier designed to operate with a single or dual supply voltage.

The input voltage range  $V_{icm}$  includes the two supply rails  $V_{CC}^+$  and  $V_{CC}^-$ .

The output reaches :

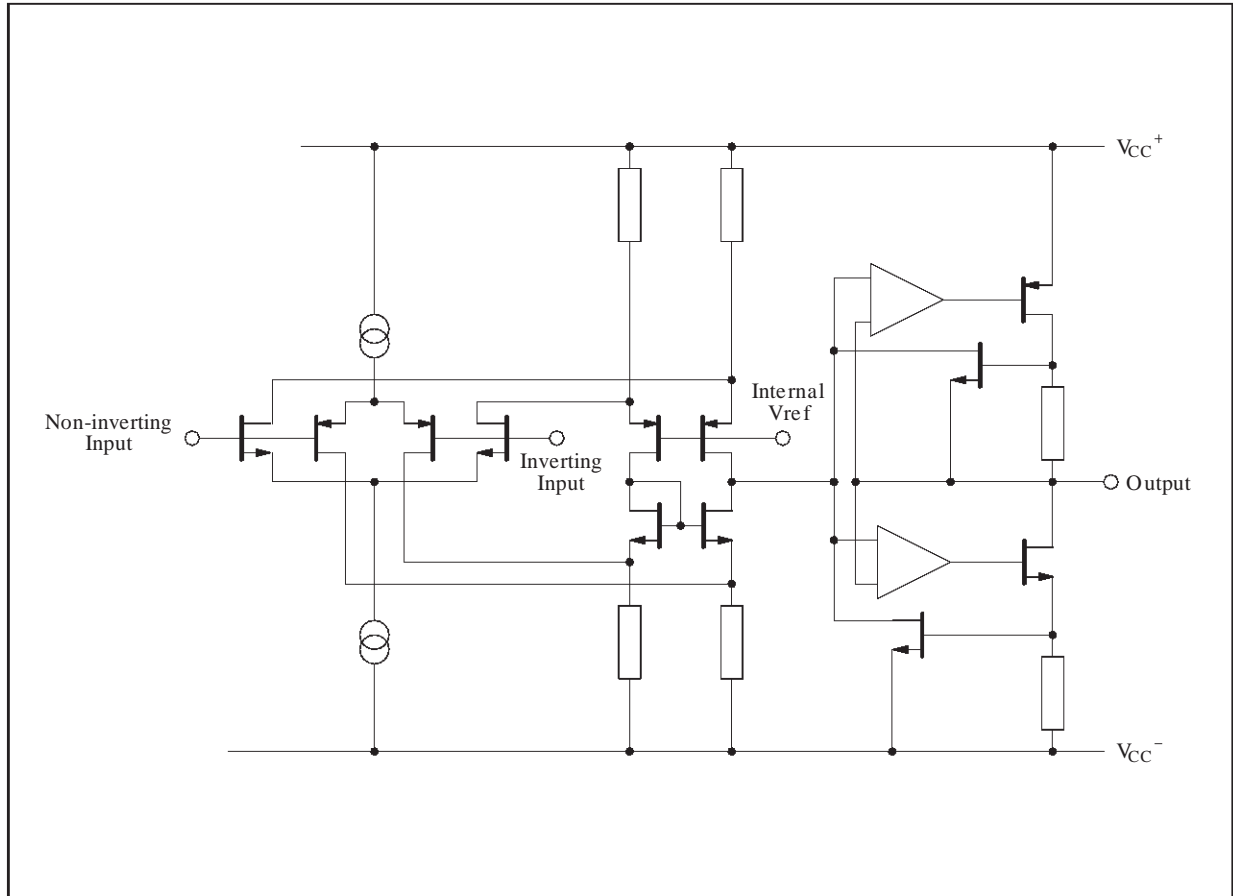
- $V_{CC}^- + 40mV$   $V_{CC}^+ - 50mV$  with  $R_L = 10k\Omega$
- $V_{CC}^- + 350mV$   $V_{CC}^+ - 350mV$  with  $R_L = 600\Omega$

This product offers a broad supply voltage operating range from 2.7V to 16V and a supply current of only 200μA/amp. ( $V_{CC} = 3V$ ).

Source and sink output current capability is typically 40mA (at  $V_{CC} = 3V$ ), fixed by an internal limitation circuit.

STMicroelectronics is offering a quad op-amp with the same features : TS914.

**SCHEMATIC DIAGRAM (1/2 TS912)**



**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage - (note 1)	18	V
$V_{id}$	Differential Input Voltage - (note 2)	$\pm 18$	V
$V_i$	Input Voltage - (note 3)	-0.3 to 18	V
$I_{in}$	Current on Inputs	$\pm 50$	mA
$I_o$	Current on Outputs	$\pm 130$	mA
$T_{oper}$	Operating Free Air Temperature Range	-40 to +125	$^{\circ}C$
	TS912I/AI/BI		
$T_{stg}$	Storage Temperature	-65 to +150	$^{\circ}C$

**Notes :** 1. All voltage values, except differential voltage are with respect to network ground terminal.  
 2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.  
 3. The magnitude of input and output voltages must never exceed  $V_{CC}^{+} + 0.3V$ .

**OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	2.7 to 16	V
$V_{icm}$	Common Mode Input Voltage Range	$V_{CC}^{-} - 0.2$ to $V_{CC}^{+} + 0.2$	V

**ELECTRICAL CHARACTERISTICS**
 $V_{CC}^+ = 3V$ ,  $V_{CC}^- = 0V$ ,  $R_L, C_L$  connected to  $V_{CC}/2$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	TS912/AI/BI			Unit	
		Min.	Typ.	Max.		
$V_{io}$	Input Offset Voltage ( $V_{ic} = V_o = V_{CC}/2$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	TS912 TS912A TS912B			10 5 2	mV
		TS912 TS912A TS912B			12 7 3	
$DV_{io}$	Input Offset Voltage Drift		5			$\mu V/^\circ C$
$I_{io}$	Input Offset Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1		100 200	pA
$I_{ib}$	Input Bias Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1		150 300	pA
$I_{CC}$	Supply Current (per amplifier, $A_{VCL} = 1$ , no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		200		300 400	$\mu A$
CMR	Common Mode Rejection Ratio $V_{ic} = 0$ to $3V$ , $V_o = 1.5V$		70			dB
SVR	Supply Voltage Rejection Ratio ( $V_{CC}^+ = 2.7$ to $3.3V$ , $V_o = V_{CC}/2$ )		50	80		dB
$A_{vd}$	Large Signal Voltage Gain ( $R_L = 10k\Omega$ , $V_o = 1.2V$ to $1.8V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$		3 2	10		V/mV
$V_{OH}$	High Level Output Voltage ( $V_{id} = 1V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$	2.95 2.9 2.3	2.96 2.6 2		V
		$R_L = 10k\Omega$ $R_L = 600\Omega$	2.8 2.1			
$V_{OL}$	Low Level Output Voltage ( $V_{id} = -1V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$			30 70 300 400 900	mV
		$R_L = 10k\Omega$ $R_L = 600\Omega$			100 600	
$I_o$	Output Short Circuit Current ( $V_{id} = \pm 1V$ )	Source ( $V_o = V_{CC}^-$ ) Sink ( $V_o = V_{CC}^+$ )	20 20	40 40		mA
GBP	Gain Bandwidth Product ( $A_{VCL} = 100$ , $R_L = 10k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ )			0.8		MHz
$SR^+$	Slew Rate ( $A_{VCL} = 1$ , $R_L = 10k\Omega$ , $C_L = 100pF$ , $V_i = 1.3V$ to $1.7V$ )			0.4		V/ $\mu s$
$SR^-$	Slew Rate ( $A_{VCL} = 1$ , $R_L = 10k\Omega$ , $C_L = 100pF$ , $V_i = 1.3V$ to $1.7V$ )			0.3		V/ $\mu s$
$\phi_m$	Phase Margin			30		Degrees
$e_n$	Equivalent Input Noise Voltage ( $R_s = 100\Omega$ , $f = 1kHz$ )			30		$\frac{nV}{\sqrt{Hz}}$

**Note 1** : Maximum values including unavoidable inaccuracies of the industrial test.

**ELECTRICAL CHARACTERISTICS**

$V_{CC}^+ = 5V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC}/2, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	TS912/AI/BI			Unit
		Min.	Typ.	Max.	
$V_{io}$	Input Offset Voltage ( $V_{ic} = V_o = V_{CC}/2$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	TS912 TS912A TS912B		10 5 2	mV
		TS912 TS912A TS912B		12 7 3	
$DV_{io}$	Input Offset Voltage Drift		5		$\mu V/^\circ C$
$I_{io}$	Input Offset Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100 200	pA
$I_{ib}$	Input Bias Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150 300	pA
$I_{CC}$	Supply Current (per amplifier, $A_{VCL} = 1$ , no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		230	350 450	$\mu A$
CMR	Common Mode Rejection Ratio $V_{ic} = 1.5$ to $3.5V, V_o = 2.5V$		60	85	dB
SVR	Supply Voltage Rejection Ratio ( $V_{CC}^+ = 3$ to $5V, V_o = V_{CC}/2$ )		55	80	dB
$A_{vd}$	Large Signal Voltage Gain ( $R_L = 10k\Omega, V_o = 1.5V$ to $3.5V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$		10 7	40	V/mV
$V_{OH}$	High Level Output Voltage ( $V_{id} = 1V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$	4.95 4.9 4.25	4.95 4.55 3.7	V
		$R_L = 10k\Omega$ $R_L = 600\Omega$	4.8 4.1		
$V_{OL}$	Low Level Output Voltage ( $V_{id} = -1V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$		40 350 1400	mV
		$R_L = 10k\Omega$ $R_L = 600\Omega$		150 750	
$I_o$	Output Short Circuit Current ( $V_{id} = \pm 1V$ )	Source ( $V_o = V_{CC}^-$ ) Sink ( $V_o = V_{CC}^+$ )	45 45	65 65	mA
GBP	Gain Bandwidth Product ( $A_{VCL} = 100, R_L = 10k\Omega, C_L = 100pF, f = 100kHz$ )			1	MHz
$SR^+$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 1V$ to $4V$ )			0.8	V/ $\mu s$
$SR^-$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 1V$ to $4V$ )			0.6	V/ $\mu s$
$e_n$	Equivalent Input Noise Voltage ( $R_s = 100\Omega, f = 1kHz$ )			30	$\frac{nV}{\sqrt{Hz}}$
$V_{O1}/V_{O2}$	Channel Separation ( $f = 1kHz$ )			120	dB
$\phi_m$	Phase Margin			30	Degrees

**Note 1** : Maximum values including unavoidable inaccuracies of the industrial test.

**ELECTRICAL CHARACTERISTICS**
 $V_{CC}^+ = 10V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC}/2, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	TS912I/AI/BI			Unit
		Min.	Typ.	Max.	
$V_{io}$	Input Offset Voltage ( $V_{ic} = V_o = V_{CC}/2$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	TS912 TS912A TS912B		10 5 2	mV
		TS912 TS912A TS912B		12 7 3	
$DV_{io}$	Input Offset Voltage Drift		5		$\mu V/^\circ C$
$I_{io}$	Input Offset Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100 200	$\mu A$
$I_{ib}$	Input Bias Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150 300	$\mu A$
$I_{CC}$	Supply Current (per amplifier, $A_{VCL} = 1$ , no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		400	600 700	$\mu A$
CMR	Common Mode Rejection Ratio $V_{ic} = 3$ to $7V, V_o = 5V$ $V_{ic} = 0$ to $10V, V_o = 5V$		60 50	90 75	dB
SVR	Supply Voltage Rejection Ratio ( $V_{CC}^+ = 5$ to $10V, V_o = V_{CC}/2$ )		60	90	dB
$A_{vd}$	Large Signal Voltage Gain ( $R_L = 10k\Omega, V_o = 2.5V$ to $7.5V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$		15 10	50	V/mV
$V_{OH}$	High Level Output Voltage ( $V_{id} = 1V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$  $R_L = 10k\Omega$ $R_L = 600\Omega$	9.95 9.85 9  9.8 8.8	9.95 9.35 7.8	V
$V_{OL}$	Low Level Output Voltage ( $V_{id} = -1V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$  $R_L = 10k\Omega$ $R_L = 600\Omega$		50 150 650 800  150 900	mV
$I_o$	Output Short Circuit Current ( $V_{id} = \pm 1V$ )	Source ( $V_o = V_{CC}^-$ ) Sink ( $V_o = V_{CC}^+$ )	45 50	65 75	mA
GBP	Gain Bandwidth Product ( $A_{VCL} = 100, R_L = 10k\Omega, C_L = 100pF, f = 100kHz$ )			1.4	MHz
$SR^+$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 2.5V$ to $7.5V$ )			1.3	V/ $\mu s$
$SR^-$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 2.5V$ to $7.5V$ )			0.8	V/ $\mu s$
$\phi_m$	Phase Margin			40	Degrees
$e_n$	Equivalent Input Noise Voltage ( $R_s = 100\Omega, f = 1kHz$ )			30	$\frac{nV}{\sqrt{Hz}}$
THD	Total Harmonic Distortion ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_o = 4.75V$ to $5.25V, f = 1kHz$ )			0.024	%
$C_{in}$	Input Capacitance			1.5	pF

**Note 1** : Maximum values including unavoidable inaccuracies of the industrial test.

TYPICAL CHARACTERISTICS

Figure 1 : Supply Current (each amplifier) vs Supply Voltage

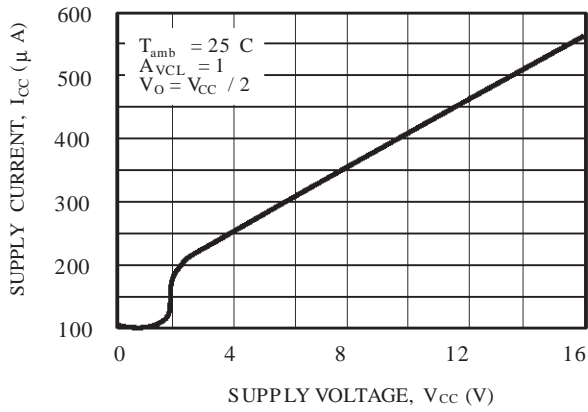


Figure 2 : Input Bias Current vs Temperature

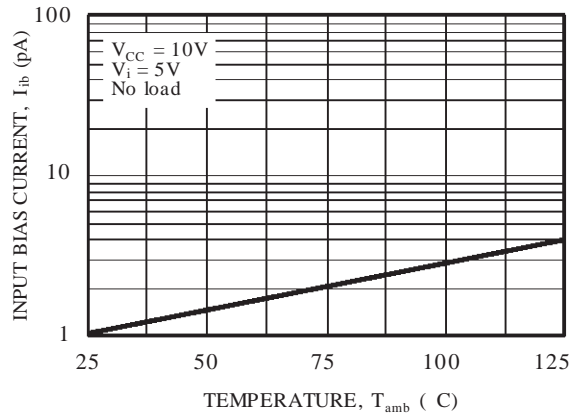


Figure 3a : High Level Output Voltage vs High Level Output Current

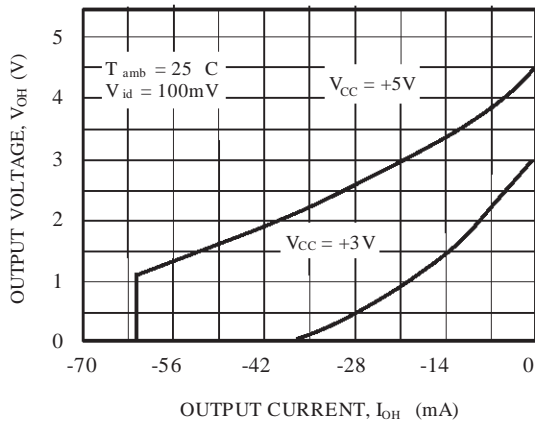


Figure 3b : High Level Output Voltage vs High Level Output Current

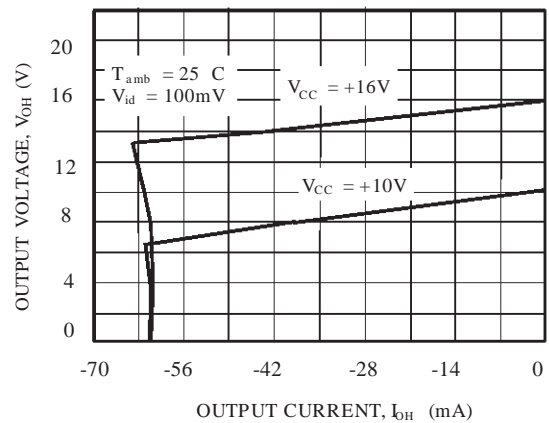


Figure 4a : Low Level Output Voltage vs Low Level Output Current

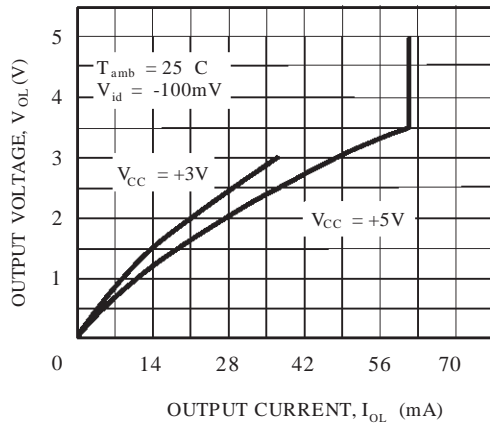


Figure 4b : Low Level Output Voltage vs Low Level Output Current

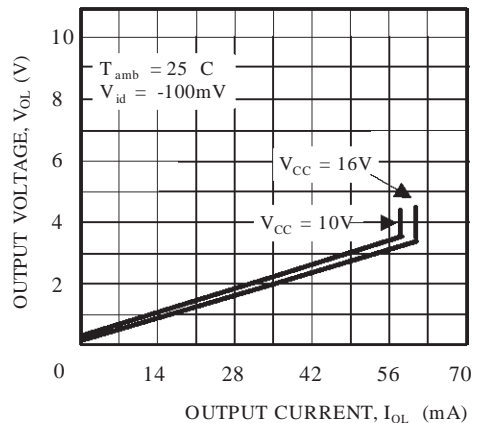


Figure 5a : Gain and Phase vs Frequency

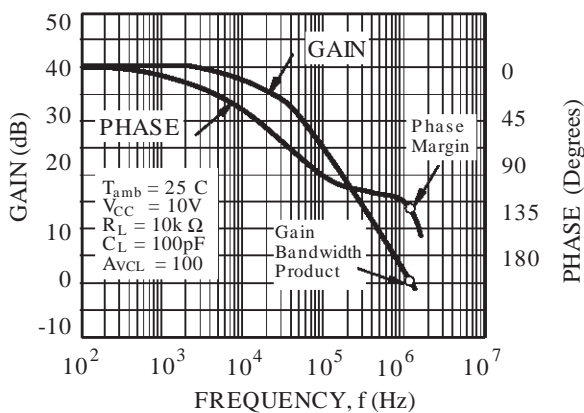


Figure 5b : Gain and Phase vs Frequency

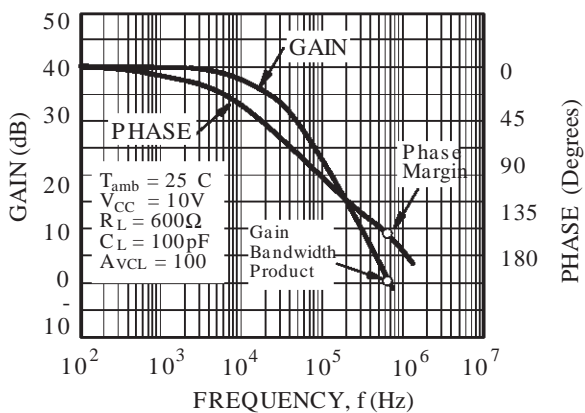


Figure 6a : Gain Bandwidth Product vs Supply Voltage

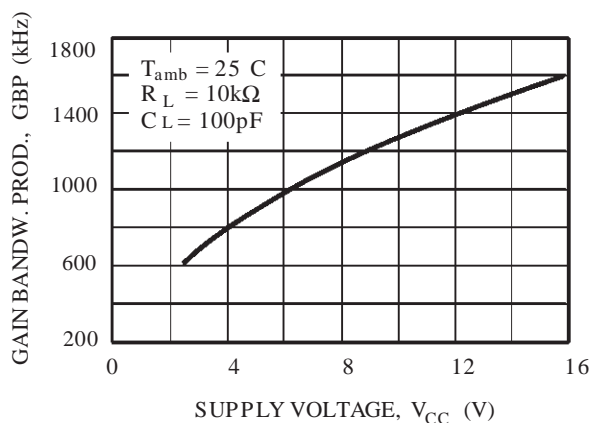


Figure 6b : Gain bandwidth Product vs Supply Voltage

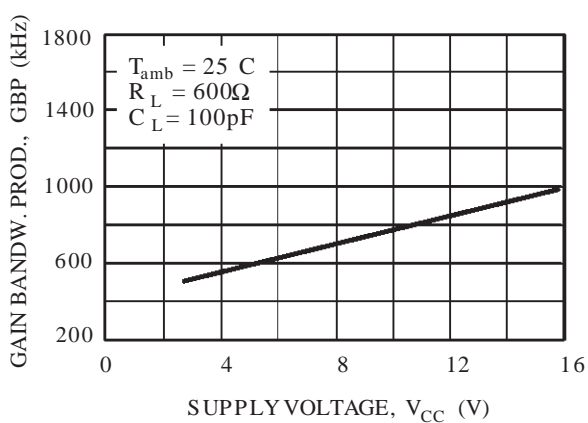


Figure 7a : Phase Margin vs Supply Voltage

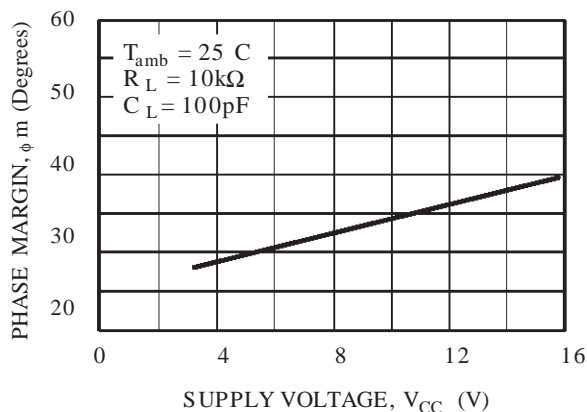
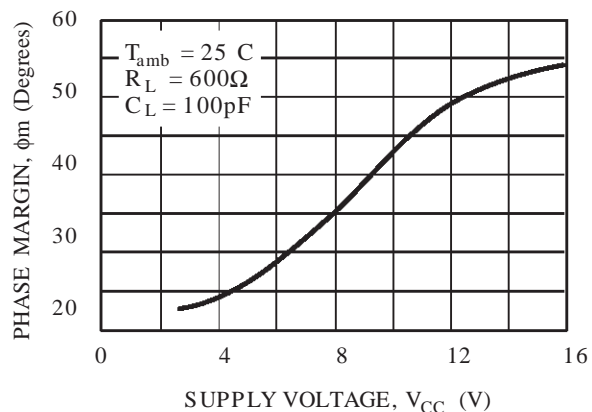
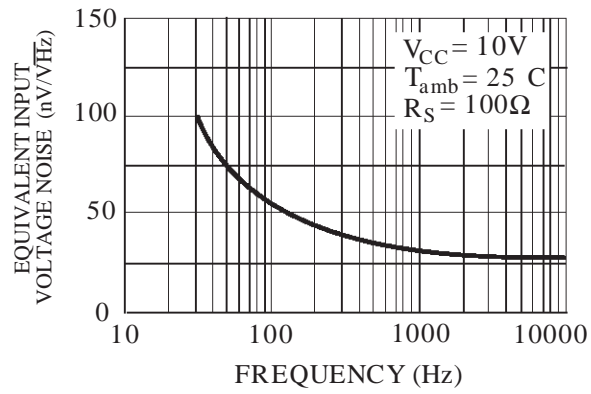


Figure 7b : Phase Margin vs Supply Voltage



**Figure 8 :** Input Voltage Noise vs Frequency





**Applies to : TS912 (V<sub>CC</sub> = 3V)**

\*\* Standard Linear Ics Macromodels, 1993.

\*\* CONNECTIONS :

- \* 1 INVERTING INPUT
- \* 2 NON-INVERTING INPUT
- \* 3 OUTPUT
- \* 4 POSITIVE POWER SUPPLY
- \* 5 NEGATIVE POWER SUPPLY

.SUBCKT TS912\_3 1 3 2 4 5 (analog)

\*\*\*\*\*

.MODEL MDTH D IS=1E-8 KF=6.564344E-14 CJO=10F

\* INPUT STAGE

- CIP 2 5 1.000000E-12
  - CIN 1 5 1.000000E-12
  - EIP 10 5 2 5 1
  - EIN 16 5 1 5 1
  - RIP 10 11 6.500000E+00
  - RIN 15 16 6.500000E+00
  - RIS 11 15 1.271505E+01
  - DIP 11 12 MDTH 400E-12
  - DIN 15 14 MDTH 400E-12
  - VOFP 12 13 DC 0.000000E+00
  - VOFN 13 14 DC 0
  - IPOL 13 5 4.000000E-05
  - CPS 11 15 2.125860E-08
  - DINN 17 13 MDTH 400E-12
  - VIN 17 5 0.000000E+00
  - DINR 15 18 MDTH 400E-12
  - VIP 4 18 0.000000E+00
  - FCP 4 5 VOFP 5.000000E+00
  - FCN 5 4 VOFN 5.000000E+00
- \* AMPLIFYING STAGE
- FIP 5 19 VOFP 2.750000E+02
  - FIN 5 19 VOFN 2.750000E+02
  - RG1 19 5 1.916825E+05
  - RG2 19 4 1.916825E+05
  - CC 19 29 2.200000E-08

- HZTP 30 29 VOFP 1.3E+03
- HZTN 5 30 VOFN 1.3E+03
- DOPM 19 22 MDTH 400E-12
- DONM 21 19 MDTH 400E-12
- HOPM 22 28 VOUT 3800
- VIPM 28 4 150
- HONM 21 27 VOUT 3800
- VINM 5 27 150
- EOUT 26 23 19 5 1
- VOUT 23 5 0
- ROUT 26 3 75
- COU 3 5 1.000000E-12
- DOP 19 68 MDTH 400E-12
- VOP 4 25 1.724
- HSCP 68 25 VSCP1 0.8E8
- DON 69 19 MDTH 400E-12
- VON 24 5 1.7419107
- HSCN 24 69 VSCN1 0.8E+08
- VSCTHP 60 61 0.0875
- \*\* VSCTHP = le seuil au dessus de vio \* 500
- \*\* c.a.d 275U-000U dus a l'offset
- DSCP1 61 63 MDTH 400E-12
- VSCP1 63 64 0
- ISCP 64 0 1.000000E-8
- DSCP2 0 64 MDTH 400E-12
- DSCN2 0 74 MDTH 400E-12
- ISCN 74 0 1.000000E-8
- VSCN1 73 74 0
- DSCN1 71 73 MDTH 400E-12
- VSCTHN 71 70 -0.55
- \*\* VSCTHN = le seuil au dessous de vio \* 2000
- \*\* c.a.d -375U-000U dus a l'offset
- ESCP 60 0 2 1 500
- ESCN 70 0 2 1 -2000

.ENDS

**ELECTRICAL CHARACTERISTICS** V<sub>CC</sub><sup>+</sup> = 3V, V<sub>CC</sub><sup>-</sup> = 0V, R<sub>L</sub>, C<sub>L</sub> connected to V<sub>CC</sub>/2, T<sub>amb</sub> = 25°C (unless otherwise specified)

Symbol	Conditions	Value	Unit
V <sub>io</sub>		0	mV
A <sub>vd</sub>	R <sub>L</sub> = 10kΩ	10	V/mV
I <sub>CC</sub>	No load, per operator	200	μA
V <sub>icm</sub>		-0.2 to 3.2	V
V <sub>OH</sub>	R <sub>L</sub> = 10kΩ	2.96	V
V <sub>OL</sub>	R <sub>L</sub> = 10kΩ	30	mV
I <sub>sink</sub>	V <sub>O</sub> = 3V	40	mA
I <sub>source</sub>	V <sub>O</sub> = 0V	40	mA
GBP	R <sub>L</sub> = 10kΩ, C <sub>L</sub> = 100pF	0.8	MHz
SR	R <sub>L</sub> = 10kΩ, C <sub>L</sub> = 100pF	0.3	V/μs

# TS912

## Applies to : TS912 (V<sub>CC</sub> = 5V)

\*\* Standard Linear Ics Macromodels, 1993.

\*\* CONNECTIONS :

- \* 1 INVERTING INPUT
- \* 2 NON-INVERTING INPUT
- \* 3 OUTPUT
- \* 4 POSITIVE POWER SUPPLY
- \* 5 NEGATIVE POWER SUPPLY
- \* 6 STANDBY

.SUBCKT TS912\_5 1 3 2 4 5 (analog)

\*\*\*\*\*

.MODEL MDTH D IS=1E-8 KF=6.564344E-14 CJO=10F

\* INPUT STAGE

CIP 2 5 1.000000E-12

CIN 1 5 1.000000E-12

EIP 10 5 2 5 1

EIN 16 5 1 5 1

RIP 10 11 6.500000E+00

RIN 15 16 6.500000E+00

RIS 11 15 7.322092E+00

DIP 11 12 MDTH 400E-12

DIN 15 14 MDTH 400E-12

VOFP 12 13 DC 0.000000E+00

VOFN 13 14 DC 0

IPOL 13 5 4.000000E-05

CPS 11 15 2.498970E-08

DINN 17 13 MDTH 400E-12

VIN 17 5 0.000000E+00

DINR 15 18 MDTH 400E-12

VIP 4 18 0.000000E+00

FCP 4 5 VOFP 5.750000E+00

FCN 5 4 VOFN 5.750000E+00

ISTB0 5 4 500N

\* AMPLIFYING STAGE

FIP 5 19 VOFP 4.400000E+02

FIN 5 19 VOFN 4.400000E+02

RG1 19 5 4.904961E+05

RG2 19 4 4.904961E+05

CC 19 29 2.200000E-08

HZTP 30 29 VOFP 1.8E+03

HZTN 5 30 VOFN 1.8E+03

DOPM 19 22 MDTH 400E-12

DONM 21 19 MDTH 400E-12

HOPM 22 28 VOUT 3800

VIPM 28 4 230

HONM 21 27 VOUT 3800

VINM 5 27 230

EOUT 26 23 19 5 1

VOUT 23 5 0

ROUT 26 3 82

COUT 3 5 1.000000E-12

DOP 19 68 MDTH 400E-12

VOP 4 25 1.724

HSCP 68 25 VSCP1 0.8E+08

DON 69 19 MDTH 400E-12

VON 24 5 1.7419107

HSCN 24 69 VSCN1 0.8E+08

VSCTHP 60 61 0.0875

\*\* VSCTHP = le seuil au dessus de vio \* 500

\*\* c.a.d 275U-000U dus a l'offset

DSCP1 61 63 MDTH 400E-12

VSCP1 63 64 0

ISCP 64 0 1.000000E-8

DSCP2 0 64 MDTH 400E-12

DSCN2 0 74 MDTH 400E-12

ISCN 74 0 1.000000E-8

VSCN1 73 74 0

DSCN1 71 73 MDTH 400E-12

VSCTHN 71 70 -0.55

\*\* VSCTHN = le seuil au dessous de vio \* 2000

\*\* c.a.d -375U-000U dus a l'offset

ESCP 60 0 2 1 500

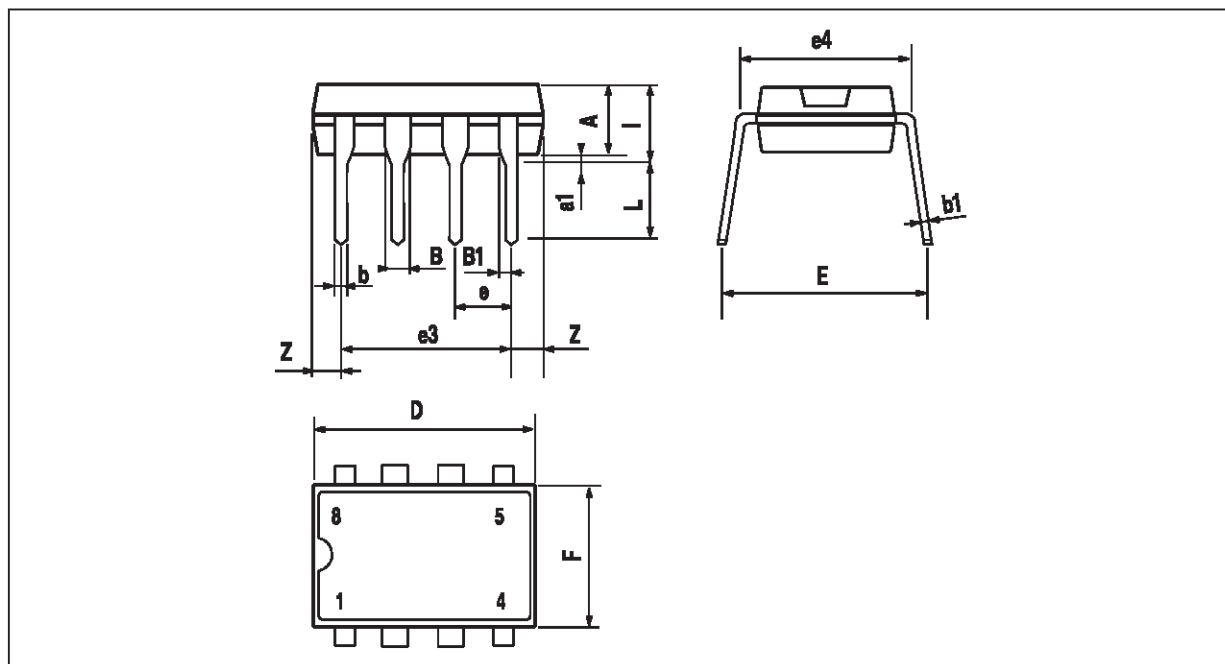
ESCN 70 0 2 1 -2000

.ENDS

**ELECTRICAL CHARACTERISTICS** V<sub>CC</sub><sup>+</sup> = 5V, V<sub>CC</sub><sup>-</sup> = 0V, R<sub>L</sub>, C<sub>L</sub> connected to V<sub>CC</sub>/2, T<sub>amb</sub> = 25°C  
(unless otherwise specified)

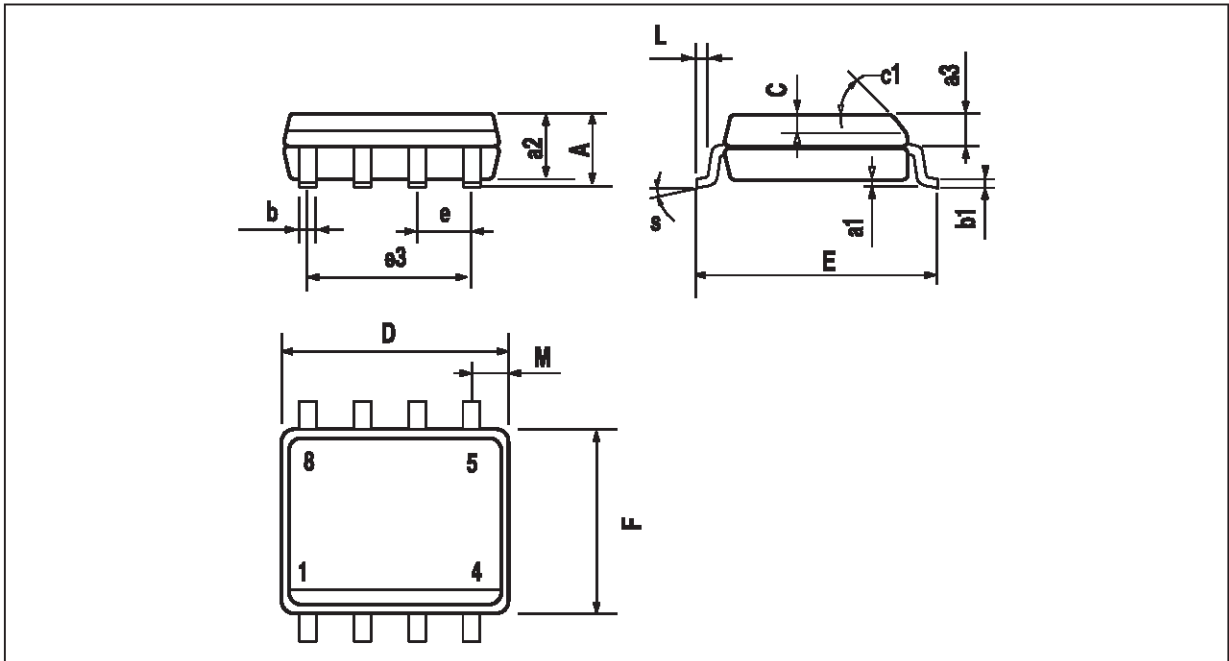
Symbol	Conditions	Value	Unit
V <sub>io</sub>		0	mV
A <sub>vd</sub>	R <sub>L</sub> = 10kΩ	50	V/mV
I <sub>CC</sub>	No load, per operator	230	μA
V <sub>icm</sub>		-0.2 to 5.2	V
V <sub>OH</sub>	R <sub>L</sub> = 10kΩ	4.95	V
V <sub>OL</sub>	R <sub>L</sub> = 10kΩ	40	mV
I <sub>sink</sub>	V <sub>O</sub> = 5V	65	mA
I <sub>source</sub>	V <sub>O</sub> = 0V	65	mA
GBP	R <sub>L</sub> = 10kΩ, C <sub>L</sub> = 100pF	1	MHz
SR	R <sub>L</sub> = 10kΩ, C <sub>L</sub> = 100pF	0.8	V/μs

**PACKAGE MECHANICAL DATA**  
8 PINS - PLASTIC DIP



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

**PACKAGE MECHANICAL DATA**  
 8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

© The ST logo is a trademark of STMicroelectronics

© 1999 STMicroelectronics – Printed in Italy – All Rights Reserved

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - France - Germany - Italy - Japan - Korea - Malaysia - Malta - Mexico - Morocco  
 The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.

© <http://www.st.com>